| APPLICA | BLE STAN | DARD | | | | | | | | | |
|--|---------------|---|---|--------|---------------------------|--|-------------|---------------------------|---------------------------------------|----------|-----|
| Operating Temperature R | | ange | -40 °C to 140 | °C (1) | | torage emperatur | e Range | | -10 °C to 6 | 0 °C | (2) |
| Rating | Voltage | | 125 V AC ⁽³⁾ | | St | Storage Humi | | ge | Relative humidity 60% max (Not dewed) | | |
| | Current | | 0.5 A | | | perating H | lumidity Ra | % max | | | |
| | | | SPEC | IFIC/ | 1OITA | NS | | | | | |
| ITEM | | TEST METHOD | | | | | RE | QUII | REMENTS | QT | АТ |
| CONSTRUCTION | | | | | | | | | | | ı |
| General Examination | | Examined visually and with a measuring instrument. | | | According to the drawing. | | | | × | × | |
| Marking | | Confirmed visually. | | | | Accordin | ng to the o | drawi | ng. | × | × |
| ELECTRIC | CAL CHARA | CTERIS | STICS | | | • | | | | | |
| Contact Resistance | | Measured at 100 mA MAX.(DC or 1000Hz) $65m\Omega$ MAX. | | | | | | | | × | _ |
| Insulation Resistance | | Measured at 250 V DC. | | | | 1000 MΩ MIN. | | | | × | _ |
| Voltage Proof | | 375 V AC applied for 1 min. | | | | No flashover or breakdown. | | | | × | _ |
| | CAL CHAR | | | | | | | | | | |
| Mating and Unmating Forces | | Measured with an applicable connector. | | | | Mating Force: 20 N MAX. Unmating Force: 2.2 N MIN. | | | | × | _ |
| Mechanical Operation | | Mated and unmated 10 times. | | | | ①Contact Resistance : 75mΩ MAX. ②No damage, cracks or looseness of parts. | | | | × | - |
| Vibration Shock | | Frequency 50~100 → 100~150 → 150~300Hz | | | | | | inuity of more than 1 μs. | × | _ | |
| | | Acceleration 98 \rightarrow 98~294 \rightarrow 294 m/s ² 1 cycle 3 min | | | | ②No damage, cracks or looseness of parts. | | | | | |
| | | 3 h for 3 axial directions (4) | | | | | | | | | |
| | | | Acceleration 980 m/s ² , duration of pulse 6 ms at 3 times for 3 axial directions. | | | | | | | × | _ |
| ENI/IRON | MENTAL C | | TERISTICS | | | | | | | | |
| Damp Heat | WENTALO | | at 60±2 °C, 90 ~ 95 % | , 1000 |) h | ①Conta | ct Resista | ance | :75mΩ MAX. | × | _ |
| (Steady state) | | Σχροσσα | ut 00=2 0, 00 00 70 | , | | ②Insulation Resistance : 1000 MΩ MIN. /3 | | | | | |
| Rapid Change of | | Temperature -40 → +140 °C | | | | ③No damage, cracks or looseness of parts. | | | | × | _ |
| Temperature | | Time $30 \rightarrow 30$ min. | | | | | | | | | |
| | | | 00 cycles. n time to chamber : within 2 \sim 3 $ m M$ | MIN) | | | | | | | |
| Cold | | Exposed at -40°C, 1000 h | | | | ①Contact Resistance : 75mΩ MAX. | | | | × | _ |
| Dry Heat | | Exposed at 140°C, 1000 h | | | | ②No damage, cracks or looseness of parts. | | | | × | _ |
| Sulfur Dioxide | | Exposed at 40±2°C, 80±5%RH, 25±5ppm 2 12 12 12 12 12 12 12 12 12 12 12 12 1 | | | | Contact Resistance : 75m Ω MAX. | | | | × | _ |
| Resistance to | | | soldering: | | | No deformation of case of excessive looseness | | | | × | _ |
| Soldering Heat | | Peak TMP: 260°CMAX Reflow TMP: 220°CMIN for 60sec | | | | of the te | erminal. | | | | |
| | | <u>/1\</u> | | | | | | | | | |
| Solderability | | Soldered at solder temperature 240±3°C for immersion duration, 3 sec. | | | | A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed. | | | | × | _ |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| | | | | | | | | | | | |
| COUN | IT DI | ESCRIPTI | ON OF REVISIONS | | DESI | GNED | | | CHECKED | DA | TE |
| /3 1 | | | | | | . ABE | | | HH. SHINDO | DO 20221 | |
| | Include tempe | erature rise caused by current-carrying. | | | APPROVED HH SHINDO | | | | 2019 | | |
| (2 | "STORAGE" r | neans a long-term storage state for the unused produc | | | CHECKED DESIGNED | | | KN. SHIBUYA | 2019 | | |
| (3 | before assem | bly to PCB. distance conforms to IEC 60664-1. | | | | | | | | | |
| , , | | distance conforms to IEC 60664-1. ctive value: 32V AC, Pollution Degree: 2 | | | | | | TK. ABE | 2019100 | | |
| | | | en connector mounting part and PCB is 0.05mm MA | | | AX. DRAWN | | | KI. YAMAZAKI | 20191007 | |
| Note QT:Qualification Test AT:Assurance Test X:Applicable Test | | | | | D | DRAWING NO. | | | ELC-376627-00-00 | | |
| HS. | | PECIFICATION SHEET | | | PAR | PART NO. | | FX26-20P-1SV | | | |
| HIR | | OSE ELECTRIC CO., LTD. | | | CODE NO. | | CL | CL0576-1002-0-00 | | | |